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## Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

### Details

Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	904
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-OFCBGA (42.5x42.5)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga80e-5ff1704c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga80e-5ff1704c</a>

## Modes of Operation

Each Slice is capable of four modes of operation: Logic, Ripple, RAM and ROM. Table 2-2 lists the modes and the capability of the Slice blocks.

**Table 2-2. Slice Modes**

	Logic	Ripple	RAM	ROM
PFU Slice	LUT 4x2 or LUT 5x1	2-bit Arithmetic Unit	SPR 16x2 DPR 16x2	ROM 16x2

## Logic Mode

In this mode, the LUTs in each Slice are configured as combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any logic function with four inputs can be generated by programming this lookup table. Since there are two LUT4s per Slice, a LUT5 can be constructed within one Slice. Larger lookup tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other Slices in the PFU.

## Ripple Mode

Ripple mode allows the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each Slice:

- Addition 2-bit
- Subtraction 2-bit
- Up counter 2-bit
- Down counter 2-bit
- Comparator functions of A and B inputs
  - A greater-than-or-equal-to B
  - A not-equal-to B
  - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

## RAM Mode

In this mode, distributed RAM can be constructed using each LUT block as a 16x1-bit memory. Through the combination of LUTs and Slices, a variety of different memories can be constructed.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the Slice. Table 2-3 shows the number of Slices required to implement different distributed RAM primitives. Dual port memories involve the pairing of two Slices, one Slice functions as the read-write port. The other companion Slice supports the read-only port. For more information on RAM mode, please see details of additional technical documentation at the end of this data sheet.

**Table 2-3. Number of Slices Required For Implementing Distributed RAM**

	SPR16x2	DPR16x2
Number of Slices	1	2

Note: SPR = Single Port RAM, DPR = Dual Port RAM

## ROM Mode

The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

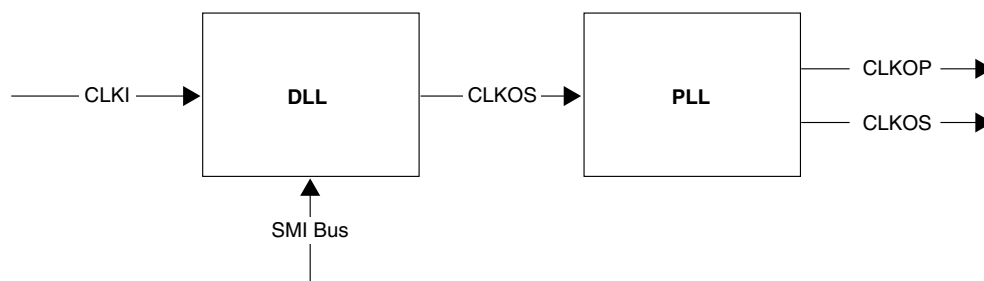
**Figure 2-13. DLL to PLL**

Figure 2-14 shows a shift of only CLKOP out in time.

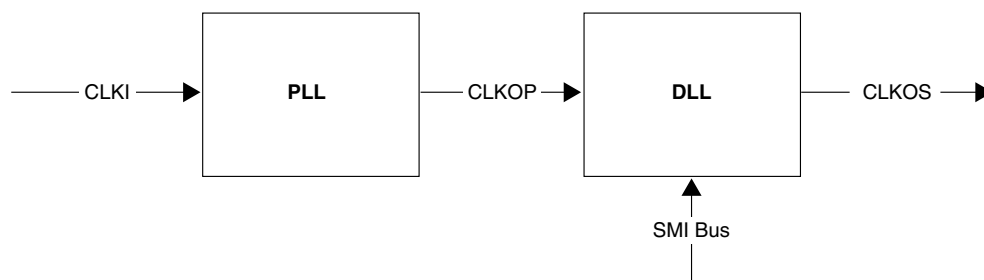
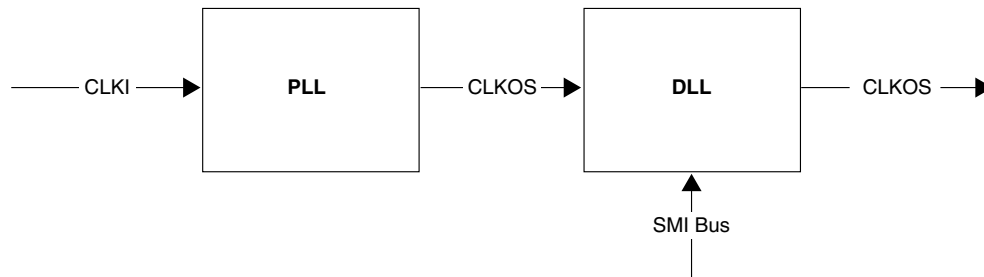
**Figure 2-14. PLL to DLL**

Figure 2-15 shows a shift of only CLKOS out in time.

**Figure 2-15. PLL to DLL**

For further information on the DLL, please see details of additional technical documentation at the end of this data sheet.

## sysMEM Memory Block

The sysMEM block can implement single port, true dual port, pseudo dual port or FIFO memories. Dedicated FIFO support logic allows the LatticeSC devices to efficiently implement FIFOs without consuming LUTs or routing resources for flag generation. Each block can be used in a variety of depths and widths as shown in Table 2-5. Memory with ranges from x1 to x18 in all modes: single port, pseudo-dual port and FIFO also providing x36.

**Table 2-10. Supported Output Standards<sup>4</sup>**

Output Standard	Drive	V <sub>CCIO</sub> (Nom)	On-chip Output Termination
<b>Single-ended Interfaces</b>			
LVTTL/D <sup>1</sup>	8mA, 16mA, 24mA	3.3	None.
LVC MOS33/D <sup>1</sup>	8mA, 16mA, 24mA	3.3	None
LVC MOS25/D <sup>1,2</sup>	4mA, 8mA, 12mA, 16mA,	2.5	None, series: 25, 33, 50, 100
LVC MOS18/D <sup>1,2</sup>	4mA, 8mA, 12mA, 16mA,	1.8	None, series: 25, 33, 50, 100
LVC MOS15/D <sup>1,2</sup>	4mA, 8mA, 12mA, 16mA,	1.5	None, series: 25, 33, 50, 100
LVC MOS12/D <sup>1,2</sup>	2mA, 4mA, 8mA, 12mA	1.2	None, series: 25, 33, 50, 100
PCIX15	N/A	1.5	None
PCI33, PCIX33, AGP1X33, AGP2X33	N/A	3.3	None
HSTL18_I	N/A	1.8	None, series: 50
HSTL18_II	N/A	1.8	None, series: 25, series + parallel to V <sub>CCIO</sub> /2: 25 + 60
HSTL15_I	N/A	1.5	None, series: 50
HSTL15_II	N/A	1.5	None, series: 25, series + parallel to V <sub>CCIO</sub> /2: 25 + 60
SSTL33_I	N/A	3.3	None
SSTL33_II	N/A	3.3	None
SSTL25_I	N/A	2.5	None, series: 50
SSTL25_II	N/A	2.5	None, series: 33, series + parallel to V <sub>CCIO</sub> /2: 33+ 60
SSTL18_I	N/A	1.8	None, series: 33
SSTL18_II	N/A	1.8	None, series: 33, series + parallel to V <sub>CCIO</sub> /2: 33+ 60
<b>Differential Interfaces</b>			
SSTL18D_I	N/A	1.8	None, series: 33
SSTL25D_I	N/A	2.5	None, series: 50
SSTL18D_II, SSTL25D_II	N/A	1.2/2.5/3.3	None, series: 33, series + parallel to V <sub>CCIO</sub> /2: 33+ 60
SSTL33D_I, II	N/A	3.3	None
HSTL15D_I, HSTL18D_I	N/A	1.5/1.8	None, series: 50
HST15D_II, HSTL18D_II	N/A	1.5/1.8	None, series: 25, series + parallel to V <sub>CCIO</sub> /2: 25 + 60
LVDS	2mA, 3.5mA, 4mA, 6mA	N/A	None
Mini-LVDS	3.5mA, 4mA, 6mA	N/A	None
BLVDS25	N/A	N/A	None
MLVDS25	N/A	N/A	None
LVPECL33 <sup>3</sup>	N/A	3.3	None
RSDS	2mA, 3.5mA, 4mA, 6mA	N/A	None

1. D refers to open drain capability.

2. User can select either drive current or driver impedances but not both.

3. Emulated with external resistors.

4. No GTL or GTL+ support.

## PCI Clamp

A programmable PCI clamp is available on the top and bottom banks of the device. The PCI clamp can be turned “ON” or “OFF” on each pin independently. The PCI clamp is used when implementing a 3.3V PCI interface. The

this allows for easy integration with the rest of the system. These capabilities make the LatticeSC ideal for many multiple power supply and hot-swap applications. The maximum current during hot socketing is 4mA. See Hot Socketing Specifications in Chapter 3 of this data sheet.

## Power-Up Requirements

To prevent high power supply and input pin currents, each VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies must have a monotonic ramp up time of 75 ms or less to reach its minimum operating voltage. Apart from VCC and VCC12, which have an additional requirement, and VCCIO and VCCAUX, which also have an additional requirement, the VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies can ramp up in any order, with no restriction on the time between them. However, the ramp time for each must be 75 ms or less. Configuration of the device will not proceed until the last power supply has reached its minimum operating voltage.

### Additional Requirement for VCC and VCC12:

VCC12 must always be higher than VCC. This condition must be maintained at ALL times, including during power-up and power-down. Note that for 1.2V only operation, it is advisable to source both of these supplies from the same power supply.

### Additional Requirement for VCCIO and VCCAUX:

If any VCCIOs are 1.2/1.5/1.8V, then VCCAUX MUST be applied before them. If any VCCIO is 1.2/1.5/1.8V and is powered up before VCCAUX, then when VCCAUX is powered up, it may drag VCCIO up with it as it crosses through the VCCIO value. (Note: If the VCCIO supply is capable of sinking current, as well as the more usual sourcing capability, this behavior is eliminated. However, the amount of current that the supply needs to sink is unknown and is likely to be in the hundreds of milliamps range).

## Power-Down Requirements

To prevent high power supply and input pin currents, power must be removed monotonically from either VCC or VCCAUX (and must reach the power-down trip point of 0.5V for VCC, 0.95V for VCCAUX) before power is removed monotonically from VCC12, any of the VCCIOs, or VCCJ. Note that VCC12 can be removed at the same time as VCC, but it cannot be removed earlier. In many applications, VCC and VCC12 will be sourced from the same power supply and so will be removed together. For systems where disturbance of the user pins is a don't care condition, the power supplies can be removed in any order as long as they power down monotonically within 200ms of each other.

Additionally, if any banks have VCCIO=3.3V nominal (potentially banks 1, 4, 5) then VCCIO for those banks must not be lower than VCCAUX during power-down. The normal variation in ramp-up times of power supplies and voltage regulators is not a concern here.

Note: The SERDES power supplies are NOT included in these requirements and have no specific sequencing requirements. However, when using the SERDES with VDDIB or VDDOB that is greater than 1.2V (1.5V nominal for example), the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in the ramp-up times of power supplies and voltage regulators is not a concern here.

## SERDES Power Supply Sequencing Requirements

When using the SERDES with 1.5V VDDIB or VDDOB supplies, the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and the 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in ramp-up times of power supplies and voltage regulators is not a concern.

### Additional Requirement for SERDES Power Supply

All VCC12 pins need to be connected on all devices independent of functionality used on the device. This analog supply is used by both the RX and TX portions of the SERDES and is used to control the core SERDES logic regardless of the SERDES being used in the design. VDDIB and VDDOB are used as supplies for the terminations on the CML input and output buffers. If a particular channel is not used, these can be UNCONNECTED (floating).

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## Density Shifting

The LatticeSC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

## Typical Building Block Function Performance

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

### Pin to Pin Performance (LVCMOS25 12 mA Drive)

Function	-7*	Units
<b>Basic Functions</b>		
32-bit Decoder	6.65	ns
Combinatorial (Pin to LUT to Pin)	5.58	ns
<b>Embedded Memory Functions (Single Port RAM)</b>		
Pin to EBR Input Register Setup (Global Clock)	1.66	ns
EBR Output Clock to Pin (Global Clock)	8.54	ns
<b>Distributed (PFU) RAM (Single Port RAM)</b>		
Pin to PFU RAM Register Setup (Global Clock)	1.32	ns
PFU RAM Clock to Pin (Global Clock)	6.83	ns

\*Typical performance per function

### Register-to-Register Performance

Function	-7*	Units
<b>Basic Functions</b>		
32-Bit Decoder	539	MHz
64-Bit Decoder	517	MHz
16:1 MUX	1003	MHz
32:1 MUX	798	MHz
16-Bit Adder	672	MHz
64-Bit Adder	353	MHz
16-Bit Counter	719	MHz
64-Bit Counter	369	MHz
32x8 SP RAM (PFU, Output Registered)	768	MHz
128x8 SP RAM (PFU, Output Registered)	545	MHz
<b>Embedded Memory Functions</b>		
Single Port RAM (512x36 Bits)	372	MHz
True Dual Port RAM 1024x18 Bits (No EBR Out Reg)	326	MHz
True dual port RAM 1024x18 Bits (EBR Reg)	372	MHz
FIFO port (A: x36 bits, B: x9 Bits, No EBR Out Reg)	353	MHz
FIFO port (A: x36 bits, B: x9 Bits, EBR Reg)	375	MHz
True DP RAM Width Cascading (1024x72)	372	MHz
<b>DSP Functions</b>		
9x9 1-stage Multiplier	209	MHz
18x18 1-Stage Multiplier	155	MHz
9x9 3-Stage Pipelined Multiplier	373	MHz
18x18 4-Stage Pipelined Multiplier	314	MHz
9x9 Constant Multiplier	372	MHz

\*Typical performance per function

**LatticeSC/M External Switching Characteristics<sup>3</sup>**

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL) <sup>2</sup>								
t <sub>CO</sub>	Global Clock Input to Output - PIO Output Register	2.83	5.74	2.83	6.11	2.83	6.49	ns
t <sub>SU</sub>	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.66	—	-0.66	—	-0.66	—	ns
t <sub>H</sub>	Global Clock Input Hold - PIO Input Register without fixed input delay	1.73	—	1.95	—	2.16	—	ns
t <sub>SU_IDLY</sub>	Global Clock Input Setup - PIO Input Register with input delay	0.86	—	1.03	—	1.20	—	ns
t <sub>H_IDLY</sub>	Global Clock Input Hold - PIO Input Register with input delay	-0.17	—	-0.17	—	-0.17	—	ns
f <sub>MAX_PFU</sub>	Global Clock frequency of PFU register	—	700	—	700	—	700	MHz
f <sub>MAX_IO</sub>	Global Clock frequency of I/O register	—	1000	—	1000	—	1000	MHz
t <sub>GC_SKEW</sub>	Global Clock skew	—	89	—	103	—	116	ps
General I/O Pin Parameters (using Primary Clock with PLL) <sup>1, 2</sup>								
t <sub>CO</sub>	Global Clock Input to Output - PIO Output Register	2.25	4.81	2.25	5.08	2.25	5.37	ns
t <sub>SU</sub>	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.07	—	-0.07	—	-0.07	—	ns
t <sub>H</sub>	Global Clock Input Hold - PIO Input Register without fixed input delay	0.80	—	0.93	—	1.04	—	ns
General I/O Pin Parameters (using Edge Clock without PLL) <sup>2</sup>								
t <sub>CO</sub>	Edge Clock Input to Output - PIO Output Register	2.38	4.77	2.38	5.04	2.38	5.33	ns
t <sub>SU</sub>	Edge Clock Input Setup - PIO Input Register without fixed input delay	-0.08	—	-0.08	—	-0.08	—	ns
t <sub>H</sub>	Edge Clock Input Hold - PIO Input Register	0.49	—	0.58	—	0.66	—	ns
t <sub>SU_IDLY</sub>	Edge Clock Input Setup - PIO Input Register with input delay	0.81	—	0.97	—	1.12	—	ns
t <sub>H_IDLY</sub>	Edge Clock Input Hold - PIO Input Register with input delay	-0.34	—	-0.34	—	-0.34	—	ns
t <sub>EC_SKEW</sub>	Edge Clock skew	—	28	—	32	—	36	ps
General I/O Pin Parameters (using Latch FF without PLL) <sup>2</sup>								
t <sub>SU</sub>	Latch FF, Input Setup - PIO Input Register without fixed input delay	-0.14	—	-0.14	—	-0.14	—	ns
t <sub>H</sub>	Latch FF, Input Hold - PIO Input Register without fixed input delay	0.58	—	0.68	—	0.77	—	ns
t <sub>SU_IDLY</sub>	Latch FF, Input Setup - PIO Input Register with input delay	0.70	—	0.68	—	0.77	—	ns
t <sub>H_IDLY</sub>	Latch FF, Input Hold - PIO Input Register with input delay	-0.30	—	-0.30	—	-0.30	—	ns

1. No PLL delay tuning (clock injection removal mode, system clock feedback).

2. Using LVCMOS25 12mA I/O. Timing adders for other supported I/O technologies are specified in the LatticeSC Family Timing Adders table.

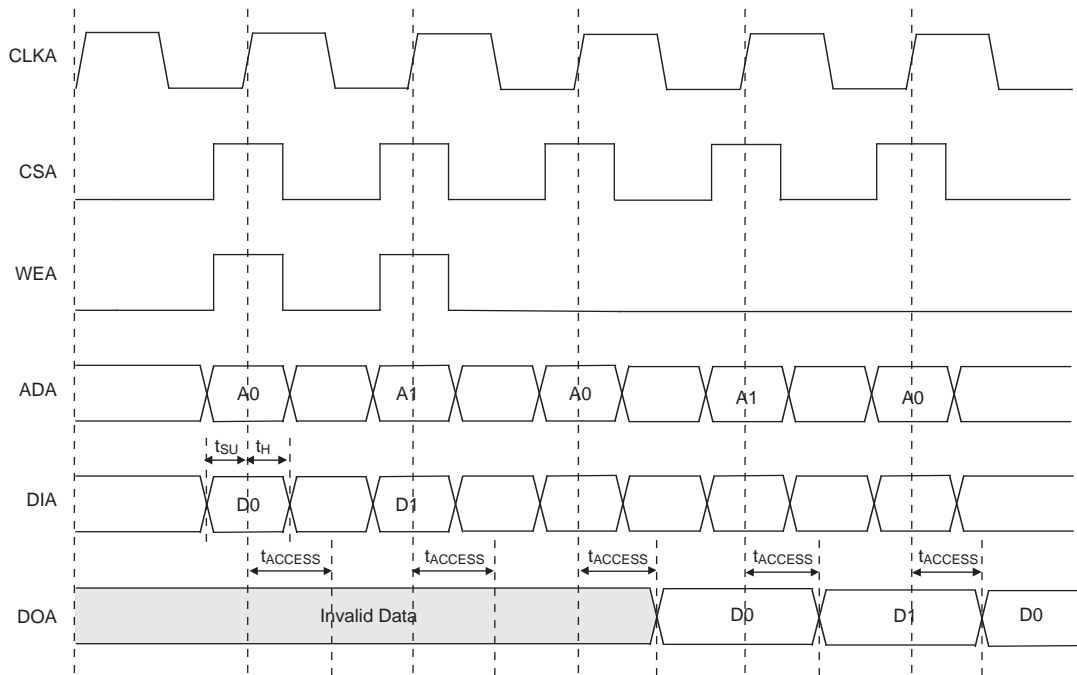
3. Complete Timing Parameters for a user design are incorporated when running ispLEVER. This is a sampling of the key timing parameters.

Timing specs are for non-AIL applications.



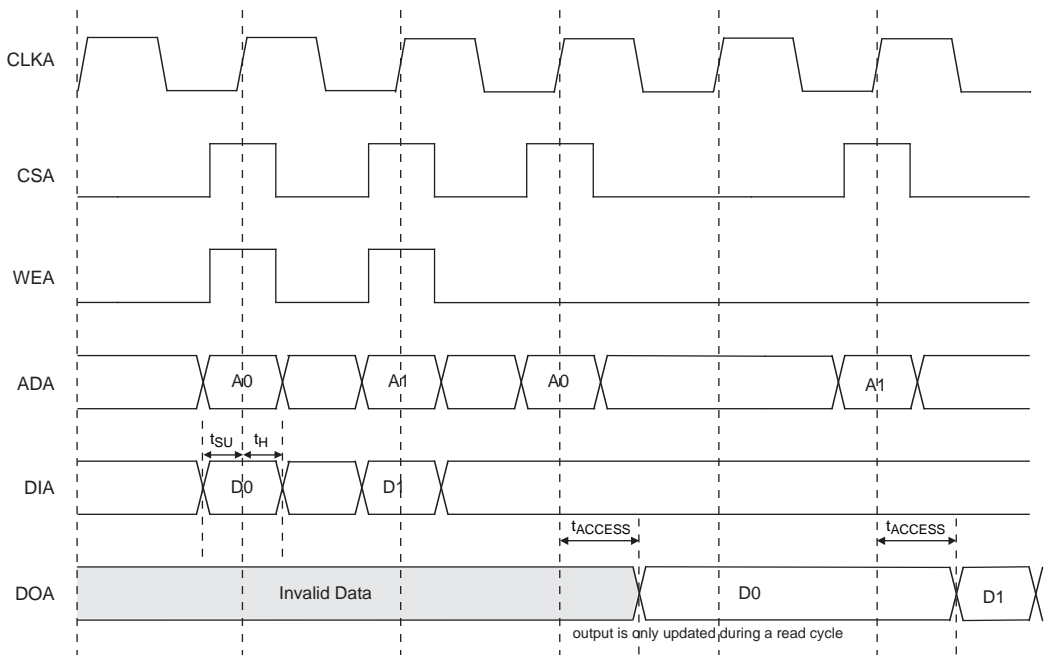
EBR Memory Timing Diagrams

Figure 3-6. Read Mode



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive of the clock.

Figure 3-7. Read Mode with Input Registers Only



**Signal Descriptions (Cont.)**

Signal Name	I/O	Description
MPI_STRBN	I	Driven active low indicates the start of a transaction on the PowerPC bus. MPI will strobe the address bus at next rising edge of clock.
MPI_ADDR[31:14]	I	Address bus driven by a PowerPC bus master. Only 18-bit width is needed. It has to be the least significant bit of the PowerPC 32-bit address A[31:14].
MPI_DAT[n:0]	I/O	Selectable data bus width from 8, and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
MPI_PAR[m:0]	I/O	Selectable parity bus width from 1, 2, and 3-bit. MPI_DP[0] for MPI_D[7:0], MPI_DP[1] for MPI_D[15:8] and MPI_DP[2] for MPI_D[23:16].
MPI_TA	O	Transfer acknowledge. Driven active low indicates that MPI received the data on the write cycle or returned data on the read cycle.
MPI_TEA	O	Transfer Error Acknowledge. Driven active low indicates that MPI detects a bus error on the internal system bus for current transaction.
MPI_RETRY	O	Active low MPI Retry requests the MPC860 to relinquish the bus and retry the cycle.
<b>Multi-chip Alignment (User I/O if not used.)</b>		
MCA_DONE_OUT	O	Multi-chip alignment done output (to second MCA chip)
MCA_DONE_IN	I	Multi-chip alignment done input (from second MCA chip)
MCA_CLK_P[1:2]_OUT	O	Multi-chip alignment clock [1:2] output (sourced by MCA master chip)
MCA_CLK_P[1:2]_IN	I	Multi-chip alignment clock [1:2] input (from MCA master chip)
TEMP	—	Temperature sensing diode pin. Dedicated pin. Accuracy is typically +/- 10°C.
<b>Miscellaneous Dedicated Pins</b>		
XRES	—	External reference resistor between this pin and ground. The reference resistor is used to calibrate the programmable terminating resistors used in the I/Os. Dedicated pin. Value: 1K ± 1% ohm.
DIFFRx	—	Only used if a differential driver is used in a bank. This DIFFRx must be connected to ground via an external 1K ± 1% ohm resistor for all banks that have a differential driver.
<b>SERDES Block (Dedicated Pins)</b>		
[A:D]_HDINPx_[L/R]	I	High-speed input (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDINNx_[L/R]	I	High-speed input (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTPx_[L/R]	O	High-speed output (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTNx_[L/R]	O	High-speed output (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_REFCLKP_[L/R]	I	Ref clock input (positive), aux channel on left [L] or right [R] side of device.
[A:D]_REFCLKN_[L/R]	I	Ref clock input (negative), aux channel on left [L] or right [R] side of device.

**LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA<sup>1, 2</sup> (Cont.)**

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF4	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AE5	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AG3	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AH2	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AD6	PB4C	5		PB4C	5	
AJ2	PB5A	5		PB5A	5	
AK2	PB5B	5		PB5B	5	
AD7	PB5C	5		PB5C	5	
AD8	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AH3	PB7A	5		PB11A	5	
AJ3	PB7B	5		PB11B	5	
AF9	PB7C	5		PB11C	5	
AE10	PB7D	5		PB11D	5	
AK3	PB8A	5		PB12A	5	
AJ4	PB8B	5		PB12B	5	
AE11	PB9A	5		PB13A	5	
AF10	PB9B	5		PB13B	5	
AK4	PB11A	5		PB16A	5	
AK5	PB11B	5		PB16B	5	
AH10	PB12A	5	PCLKT5_3	PB20A	5	PCLKT5_3
AH11	PB12B	5	PCLKC5_3	PB20B	5	PCLKC5_3
AF13	PB12C	5	PCLKT5_4	PB20C	5	PCLKT5_4
AE14	PB12D	5	PCLKC5_4	PB20D	5	PCLKC5_4
AK6	PB13A	5	PCLKT5_5	PB21A	5	PCLKT5_5
AK7	PB13B	5	PCLKC5_5	PB21B	5	PCLKC5_5
AF14	PB13C	5		PB21C	5	
AJ11	PB15A	5	PCLKT5_0	PB23A	5	PCLKT5_0
AJ12	PB15B	5	PCLKC5_0	PB23B	5	PCLKC5_0
AH13	PB15D	5	VREF2_5	PB23D	5	VREF2_5
AK8	PB16A	5	PCLKT5_1	PB24A	5	PCLKT5_1
AK9	PB16B	5	PCLKC5_1	PB24B	5	PCLKC5_1
AH14	PB17A	5	PCLKT5_2	PB25A	5	PCLKT5_2
AG14	PB17B	5	PCLKC5_2	PB25B	5	PCLKC5_2
AK10	PB19A	5		PB28A	5	
AK11	PB19B	5		PB28B	5	
AH15	PB20A	5		PB29A	5	
AG15	PB20B	5		PB29B	5	
AH12	PB21A	5		PB31A	5	
AJ13	PB21B	5		PB31B	5	
AD15	PB21C	5		PB31C	5	
AE15	PB21D	5		PB31D	5	
AK12	PB23A	5		PB32A	5	
AK13	PB23B	5		PB32B	5	
AJ14	PB24A	5		PB33A	5	
AJ15	PB24B	5		PB33B	5	

**LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA<sup>1, 2</sup> (Cont.)**

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AJ27	GND	-		GND	-	
AF23	GND	-		GND	-	
AF22	GND	-		GND	-	
AE27	GND	-		GND	-	
AA27	GND	-		GND	-	
AB29	GND	-		GND	-	
Y26	GND	-		GND	-	
AC30	GND	-		GND	-	
Y29	GND	-		GND	-	
F30	GND	-		GND	-	
E27	GND	-		GND	-	
F27	GND	-		GND	-	
P25	GND	-		GND	-	
H29	GND	-		GND	-	
K29	GND	-		GND	-	
R24	GND	-		GND	-	
M28	GND	-		GND	-	
J27	GND	-		GND	-	
N26	GND	-		GND	-	
E20	GND	-		GND	-	
E21	GND	-		GND	-	
F21	GND	-		GND	-	
F23	GND	-		GND	-	
G23	GND	-		GND	-	
D21	GND	-		GND	-	
D20	GND	-		GND	-	
E18	GND	-		GND	-	
C20	GND	-		GND	-	
C11	GND	-		GND	-	
A12	GND	-		GND	-	
E11	GND	-		GND	-	
F8	GND	-		GND	-	
G8	GND	-		GND	-	
D11	GND	-		GND	-	
D10	GND	-		GND	-	
H7	GND	-		GND	-	
F10	GND	-		GND	-	
E10	GND	-		GND	-	
AC16	NC	-		NC	-	
J22	VCC	-		VCC	-	
J9	VCC	-		VCC	-	
B2	NC	-		NC	-	
C2	RESPN_ULC	-		RESPN_ULC	-	
C29	RESPN_URC	-		RESPN_URC	-	

**LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA<sup>1, 2</sup> (Cont.)**

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y4	PR48B	3		PR63B	3	
W4	PR48A	3		PR63A	3	
W11	PR47D	3		PR60D	3	
V11	PR47C	3		PR60C	3	
W2	PR47B	3		PR60B	3	
V2	PR47A	3		PR60A	3	
W9	PR45D	3		PR57D	3	
V9	PR45C	3		PR57C	3	
V1	PR45B	3		PR57B	3	
U1	PR45A	3		PR57A	3	
W10	PR44D	3		PR56D	3	
V10	PR44C	3		PR56C	3	
U2	PR44B	3		PR56B	3	
T2	PR44A	3		PR56A	3	
Y8	PR43D	3		PR55D	3	
W8	PR43C	3	VREF1_3	PR55C	3	VREF1_3
W5	PR43B	3		PR55B	3	
V5	PR43A	3		PR55A	3	
V7	PR40D	3	PCLKC3_2	PR52D	3	PCLKC3_2
U7	PR40C	3	PCLKT3_2	PR52C	3	PCLKT3_2
T1	PR40B	3		PR52B	3	
R1	PR40A	3		PR52A	3	
V8	PR39D	3	PCLKC3_3	PR51D	3	PCLKC3_3
U8	PR39C	3	PCLKT3_3	PR51C	3	PCLKT3_3
U5	PR39B	3		PR51B	3	
T5	PR39A	3		PR51A	3	
V6	PR38D	3	PCLKC3_1	PR50D	3	PCLKC3_1
U6	PR38C	3	PCLKT3_1	PR50C	3	PCLKT3_1
T4	PR38B	3	PCLKC3_0	PR50B	3	PCLKC3_0
T3	PR38A	3	PCLKT3_0	PR50A	3	PCLKT3_0
U9	PR36D	2	PCLKC2_2	PR48D	2	PCLKC2_2
T9	PR36C	2	PCLKT2_2	PR48C	2	PCLKT2_2
R2	PR36B	2	PCLKC2_0	PR48B	2	PCLKC2_0
P2	PR36A	2	PCLKT2_0	PR48A	2	PCLKT2_0
T11	PR35D	2	PCLKC2_3	PR47D	2	PCLKC2_3
U11	PR35C	2	PCLKT2_3	PR47C	2	PCLKT2_3
R4	PR35B	2	PCLKC2_1	PR47B	2	PCLKC2_1
R3	PR35A	2	PCLKT2_1	PR47A	2	PCLKT2_1
T8	PR34D	2		PR46D	2	
R8	PR34C	2		PR46C	2	
P1	PR34B	2		PR46B	2	
N1	PR34A	2		PR46A	2	
R6	PR31D	2		PR43D	2	
P6	PR31C	2		PR43C	2	
M1	PR31B	2		PR43B	2	

**LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA<sup>1, 2</sup> (Cont.)**

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
R7	NC	-		PR39D	2	
P7	NC	-		PR39C	2	
N3	NC	-		PR39B	2	
M3	NC	-		PR39A	2	
H1	NC	-		PR26B	2	
G1	NC	-		PR26A	2	
L5	NC	-		PR25B	2	
K5	NC	-		PR25A	2	
G2	NC	-		PR24B	2	
F2	NC	-		PR24A	2	
F1	NC	-		PR22B	2	
E1	NC	-		PR22A	2	
A2	GND	-		GND	-	
A33	GND	-		GND	-	
AA15	GND	-		GND	-	
AA20	GND	-		GND	-	
AA32	GND	-		GND	-	
AA4	GND	-		GND	-	
AB28	GND	-		GND	-	
AB6	GND	-		GND	-	
AC11	GND	-		GND	-	
AC18	GND	-		GND	-	
AC25	GND	-		GND	-	
AD23	GND	-		GND	-	
AD3	GND	-		GND	-	
AD31	GND	-		GND	-	
AE12	GND	-		GND	-	
AE15	GND	-		GND	-	
AE29	GND	-		GND	-	
AE7	GND	-		GND	-	
AE9	GND	-		GND	-	
AF20	GND	-		GND	-	
AF26	GND	-		GND	-	
AG32	GND	-		GND	-	
AG4	GND	-		GND	-	
AH13	GND	-		GND	-	
AH19	GND	-		GND	-	
AH25	GND	-		GND	-	
AH7	GND	-		GND	-	
AJ10	GND	-		GND	-	
AJ16	GND	-		GND	-	
AJ22	GND	-		GND	-	
AJ28	GND	-		GND	-	
AK3	GND	-		GND	-	
AK31	GND	-		GND	-	

**LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA<sup>1,2</sup> (Cont.)**

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
BA19	PB73A	4		PB87A	4	
BA18	PB73B	4		PB87B	4	
AU19	PB73C	4		PB87C	4	
AU18	PB73D	4		PB87D	4	
AV19	PB74A	4	PCLKT4_2	PB89A	4	PCLKT4_2
AV18	PB74B	4	PCLKC4_2	PB89B	4	PCLKC4_2
AN19	PB74C	4	PCLKT4_7	PB89C	4	PCLKT4_7
AP19	PB74D	4	PCLKC4_7	PB89D	4	PCLKC4_7
BB17	PB75A	4	PCLKT4_1	PB90A	4	PCLKT4_1
BB16	PB75B	4	PCLKC4_1	PB90B	4	PCLKC4_1
AT19	PB75C	4	PCLKT4_6	PB90C	4	PCLKT4_6
AT18	PB75D	4	PCLKC4_6	PB90D	4	PCLKC4_6
BA17	PB77A	4	PCLKT4_0	PB91A	4	PCLKT4_0
BA16	PB77B	4	PCLKC4_0	PB91B	4	PCLKC4_0
AR19	PB77C	4	VREF2_4	PB91C	4	VREF2_4
AR18	PB77D	4		PB91D	4	
AY17	PB79A	4	PCLKT4_5	PB93A	4	PCLKT4_5
AY16	PB79B	4	PCLKC4_5	PB93B	4	PCLKC4_5
AN18	PB79C	4		PB93C	4	
AP18	PB79D	4		PB93D	4	
AW17	PB80A	4	PCLKT4_3	PB94A	4	PCLKT4_3
AW16	PB80B	4	PCLKC4_3	PB94B	4	PCLKC4_3
AU17	PB80C	4	PCLKT4_4	PB94C	4	PCLKT4_4
AU16	PB80D	4	PCLKC4_4	PB94D	4	PCLKC4_4
AV17	PB81A	4		PB95A	4	
AV16	PB81B	4		PB95B	4	
AL18	PB81C	4		PB95C	4	
AM18	PB81D	4		PB95D	4	
BB15	PB83A	4		PB97A	4	
BB14	PB83B	4		PB97B	4	
AP17	PB83C	4		PB97C	4	
AN17	PB83D	4		PB97D	4	
BA15	PB84A	4		PB98A	4	
BA14	PB84B	4		PB98B	4	
AT16	PB84C	4		PB98C	4	
AT15	PB84D	4		PB98D	4	
AV15	PB85A	4		PB99A	4	
AV14	PB85B	4		PB99B	4	
AR16	PB85C	4		PB99C	4	
AR15	PB85D	4		PB99D	4	
AY14	PB87A	4		PB101A	4	
AY13	PB87B	4		PB101B	4	
AU15	PB87C	4		PB101C	4	
AU14	PB87D	4		PB101D	4	
BB13	PB88A	4		PB102A	4	

**LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA<sup>1, 2</sup> (Cont.)**

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AE1	PR74A	3		PR88A	3	
AF12	PR73D	3		PR87D	3	
AE12	PR73C	3		PR87C	3	
AF2	PR73B	3		PR87B	3	
AE2	PR73A	3		PR87A	3	
AF11	PR72D	3		PR86D	3	
AE11	PR72C	3		PR86C	3	
AF5	PR72B	3		PR86B	3	
AE5	PR72A	3		PR86A	3	
AF10	PR69D	3		PR83D	3	
AE10	PR69C	3		PR83C	3	
AD1	PR69B	3		PR83B	3	
AC1	PR69A	3		PR83A	3	
AF9	PR68D	3		PR82D	3	
AE9	PR68C	3		PR82C	3	
AD2	PR68B	3		PR82B	3	
AC2	PR68A	3		PR82A	3	
AF6	PR67D	3		PR81D	3	
AE6	PR67C	3		PR81C	3	
AD3	PR67B	3		PR81B	3	
AC3	PR67A	3		PR81A	3	
AE8	PR65D	3		PR79D	3	
AD8	PR65C	3		PR79C	3	
AD4	PR65B	3		PR79B	3	
AC4	PR65A	3		PR79A	3	
AE7	PR64D	3		PR78D	3	
AD7	PR64C	3		PR78C	3	
AD5	PR64B	3		PR78B	3	
AC5	PR64A	3		PR78A	3	
AD6	PR63D	3		PR77D	3	
AC6	PR63C	3		PR77C	3	
AB1	PR63B	3		PR77B	3	
AA1	PR63A	3		PR77A	3	
AD9	PR61D	3		PR75D	3	
AC9	PR61C	3		PR75C	3	
AB2	PR61B	3		PR75B	3	
AA2	PR61A	3		PR75A	3	
AD14	PR60D	3		PR74D	3	
AC14	PR60C	3		PR74C	3	
AB5	PR60B	3		PR74B	3	
AA5	PR60A	3		PR74A	3	
AD10	PR59D	3		PR73D	3	
AC10	PR59C	3		PR73C	3	
Y1	PR59B	3		PR73B	3	
W1	PR59A	3		PR73A	3	



**LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA<sup>1,2</sup> (Cont.)**

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AG38	NC	-		PL95A	6	
AH38	NC	-		PL95B	6	
AJ39	NC	-		PL100A	6	
AK39	NC	-		PL100B	6	
AL41	NC	-		PL105A	6	
AM41	NC	-		PL105B	6	
AN40	NC	-		PL108A	6	
AM40	NC	-		PL108B	6	
AM39	NC	-		PL111A	6	
AN39	NC	-		PL111B	6	
AR42	NC	-		PL113A	6	
AT42	NC	-		PL113B	6	
AT1	NC	-		PR113B	3	
AR1	NC	-		PR113A	3	
AN4	NC	-		PR111B	3	
AM4	NC	-		PR111A	3	
AM3	NC	-		PR108B	3	
AN3	NC	-		PR108A	3	
AM2	NC	-		PR105B	3	
AL2	NC	-		PR105A	3	
AK4	NC	-		PR100B	3	
AJ4	NC	-		PR100A	3	
AH5	NC	-		PR95B	3	
AG5	NC	-		PR95A	3	
P6	NC	-		PR39B	2	
N6	NC	-		PR39A	2	
L3	NC	-		PR36B	2	
K3	NC	-		PR36A	2	
M5	NC	-		PR35A	2	
L4	NC	-		PR32B	2	
K4	NC	-		PR32A	2	
A2	GND	-		GND	-	
A41	GND	-		GND	-	
AA20	GND	-		GND	-	
AA23	GND	-		GND	-	
AA3	GND	-		GND	-	
AA39	GND	-		GND	-	
AB20	GND	-		GND	-	
AB23	GND	-		GND	-	
AB4	GND	-		GND	-	
AB40	GND	-		GND	-	
AC17	GND	-		GND	-	
AC19	GND	-		GND	-	
AC21	GND	-		GND	-	
AC22	GND	-		GND	-	

**Lead-Free Packaging****Commercial**

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-7FN256C	-7	Lead-Free fpBGA	256	COM	15.2
LFSC3GA15E-6FN256C	-6	Lead-Free fpBGA	256	COM	15.2
LFSC3GA15E-5FN256C	-5	Lead-Free fpBGA	256	COM	15.2
LFSC3GA15E-7FN900C	-7	Lead-Free fpBGA	900	COM	15.2
LFSC3GA15E-6FN900C	-6	Lead-Free fpBGA	900	COM	15.2
LFSC3GA15E-5FN900C	-5	Lead-Free fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-7FN256C	-7	Lead-Free fpBGA	256	COM	15.2
LFSCM3GA15EP1-6FN256C	-6	Lead-Free fpBGA	256	COM	15.2
LFSCM3GA15EP1-5FN256C	-5	Lead-Free fpBGA	256	COM	15.2
LFSCM3GA15EP1-7FN900C	-7	Lead-Free fpBGA	900	COM	15.2
LFSCM3GA15EP1-6FN900C	-6	Lead-Free fpBGA	900	COM	15.2
LFSCM3GA15EP1-5FN900C	-5	Lead-Free fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-7FN900C	-7	Lead-Free fpBGA	900	COM	25.4
LFSC3GA25E-6FN900C	-6	Lead-Free fpBGA	900	COM	25.4
LFSC3GA25E-5FN900C	-5	Lead-Free fpBGA	900	COM	25.4
LFSC3GA25E-7FFN1020C <sup>1</sup>	-7	Lead-Free Organic fcBGA	1020	COM	25.4
LFSC3GA25E-6FFN1020C <sup>1</sup>	-6	Lead-Free Organic fcBGA	1020	COM	25.4
LFSC3GA25E-5FFN1020C <sup>1</sup>	-5	Lead-Free Organic fcBGA	1020	COM	25.4
LFSC3GA25E-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-7FN900C	-7	Lead-Free fpBGA	900	COM	25.4
LFSCM3GA25EP1-6FN900C	-6	Lead-Free fpBGA	900	COM	25.4
LFSCM3GA25EP1-5FN900C	-5	Lead-Free fpBGA	900	COM	25.4
LFSCM3GA25EP1-7FFN1020C <sup>1</sup>	-7	Lead-Free Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-6FFN1020C <sup>1</sup>	-6	Lead-Free Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-5FFN1020C <sup>1</sup>	-5	Lead-Free Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

## Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-7FFN1020C <sup>1</sup>	-7	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-6FFN1020C <sup>1</sup>	-6	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-5FFN1020C <sup>1</sup>	-5	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-7FCN1152C <sup>2</sup>	-7	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-6FCN1152C <sup>2</sup>	-6	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-5FCN1152C <sup>2</sup>	-5	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-7FFN1020C <sup>1</sup>	-7	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-6FFN1020C <sup>1</sup>	-6	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-5FFN1020C <sup>1</sup>	-5	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-7FFAN1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-6FFAN1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-5FFAN1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-7FCN1152C <sup>2</sup>	-7	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FCN1152C <sup>2</sup>	-6	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FCN1152C <sup>2</sup>	-5	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-7FFN1152C	-7	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FFN1152C	-6	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FFN1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

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**Commercial, Cont.**

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FCN1152C <sup>1</sup>	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FCN1152C <sup>1</sup>	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FCN1704C <sup>1</sup>	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FCN1704C <sup>1</sup>	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

**Industrial**

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-6FN256I	-6	Lead-Free fpBGA	256	IND	15.2
LFSC3GA15E-5FN256I	-5	Lead-Free fpBGA	256	IND	15.2
LFSC3GA15E-6FN900I	-6	Lead-Free fpBGA	900	IND	15.2
LFSC3GA15E-5FN900I	-5	Lead-Free fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-6FN256I	-6	Lead-Free fpBGA	256	IND	15.2
LFSCM3GA15EP1-5FN256I	-5	Lead-Free fpBGA	256	IND	15.2
LFSCM3GA15EP1-6FN900I	-6	Lead-Free fpBGA	900	IND	15.2
LFSCM3GA15EP1-5FN900I	-5	Lead-Free fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-6FN900I	-6	Lead-Free fpBGA	900	IND	25.4
LFSC3GA25E-5FN900I	-5	Lead-Free fpBGA	900	IND	25.4
LFSC3GA25E-6FFN1020I <sup>1</sup>	-6	Lead-Free Organic fcBGA	1020	IND	25.4
LFSC3GA25E-5FFN1020I <sup>1</sup>	-5	Lead-Free Organic fcBGA	1020	IND	25.4
LFSC3GA25E-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4
LFSC3GA25E-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-6FN900I	-6	Lead-Free fpBGA	900	IND	25.4
LFSCM3GA25EP1-5FN900I	-5	Lead-Free fpBGA	900	IND	25.4
LFSCM3GA25EP1-6FFN1020I <sup>1</sup>	-6	Lead-Free Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-5FFN1020I <sup>1</sup>	-5	Lead-Free Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4
LFSCM3GA25EP1-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-6FFN1020I <sup>1</sup>	-6	Lead-Free Organic fcBGA	1020	IND	40.4
LFSC3GA40E-5FFN1020I <sup>1</sup>	-5	Lead-Free Organic fcBGA	1020	IND	40.4
LFSC3GA40E-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-6FCN1152I <sup>2</sup>	-6	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-5FCN1152I <sup>2</sup>	-5	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	40.4
LFSC3GA40E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).